Temperature Correction of Radiometric and Geometric Models for an Uncooled CCD Camera in the Near Infrared

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Abstract—This paper presents radiometric and geometric models for both temperature and displacement noncontact measurements using an uncooled charge-coupled device (CCD) video camera. Such techniques (“one sensor-two measures”) represent an interest in many industrial low cost applications and scientific domains.

To benefit from both measurements, we have to use the camera’s spectral response in the near infrared spectral band from 0.75 to 1.1 μm . In this spectral band, the temperature variations of an uncooled CCD camera are taken into account in the radiometric and geometric models. By using physical models for CCD camera, we quantify detector’s quantum efficiency, sensor noise and spatial resolution as a function of the wavelength and of the detector temperature. These models are confirmed by experimental results of calibration with a low cost uncooled camera based on a Sony detector and operating over the detector temperature range of -30 to -50° .

Index Terms—Camera calibration, charge-coupled device (CCD) cameras, geometric model, modulation transfer function (MTF), noise estimation, radiometric model, sensor modeling, spatial resolution, temperature.

I. INTRODUCTION

IN RECENT YEARS, the material research center of the Ecole des Mines d’Albi-Carmaux (CROMeP) has developed temperature gradient measurements based on infrared thermographic cameras [1]. At the same time, a team has been involved in three-dimensional (3-D) deformation [2] and distortion [3] measurements using charge-coupled device (CCD) cameras. To improve maintenance and cost in industrial applications, we have to measure both temperature and dimensional characteristics using only one noncontact sensor. The system must be able to measure a temperature from 350 to 1000 $^\circ\text{C}$ with a tolerance of $\pm 25^\circ\text{C}$ and spatial surface deformations of ± 0.1 mm with an observation distance of 1 m.

However, the main difficulty is the temperature measurement. Adopted from the spectral photon luminance L_s of a real source

[4], the sensor operates in the infrared spectral band. The luminance is described by the Planck’s radiation law, as follows:

$$L_s(\lambda, T) = \varepsilon \frac{C_3 \lambda^4}{\exp\left(\frac{C_2}{\lambda T}\right) - 1} \quad (\text{photons/s} \cdot \text{m}^2 \cdot \text{sr} \cdot \mu\text{m}) \quad (1)$$

where T is the absolute temperature (Kelvin), ε is the emissivity of the source, h is Planck’s constant ($h = 6.6210 \cdot 10^{-34}$ Js), c is the speed of light ($c = 310^8$ ms) and k is Boltzmann’s constant ($k = 1.380 \cdot 10^{-23}$ J/K). Finally, the second and the third radiation constants are respectively given by $C_2 = hc/k$ μmK and $C_3 = 2c$.

Thus, applying relation (1) when temperature T equals 350 $^\circ\text{C}$ (and, respectively, 1000 $^\circ\text{C}$), the luminance reaches a peak at a wavelength value of 4.65 μm (and respectively 2.25 μm). But, the traditional 3–5 μm infrared cameras, are often limited by their fragility, high cost and low spatial resolution. In the near infrared spectral band (NIR) (0.75–1.1 μm), luminance values (from 10^{16} to 2×10^{21} photons/ $\text{sm}^2\text{sr}\mu\text{m}$) allow a measurement of a temperature from 350 to 1000 $^\circ\text{C}$. Moreover, CCD cameras operating in NIR spectral band are relatively low cost, light weight, compact and have high spatial resolution. They can measure through a glass window and present less sensitivity to uncertainties concerning the emissivity of the object. A few industrial applications with low cost CCD cameras related to high-temperature measurement over the range $[800\text{--}1800^\circ]$ are reported in [5] and [6]. In this paper, our objective is to measure temperatures below the usual value of 800 $^\circ$, in low illuminated conditions with noise considerations like in [7]. Additionally, the new radiometric model presented in this paper takes into account the variation of the detector temperature of low cost uncooled CCD devices widely used in industrial situations. This radiometric model is based on the study of CCD sensor properties like quantum efficiency and noise. Moreover, we examine the spatial resolution changes in NIR spectral band for the same range of temperatures. From the study of the modulation transfer function (MTF), we deduce the influence of wavelength and detector temperature on the intrinsic parameters required in the “pin-hole” geometric model [8] used in our applications. Finally, after characterization and calibration procedures, some advantages and limitations of this strategy of “one sensor-two measurements” are discussed.

II. RADIOMETRIC MODEL

The radiometric model is determined by a formal relationship between the temperature T of an ideal blackbody source and the

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Fig. 1. Temperature calibration situation.

analog V_c or digital I_D camera CCD output. Usually, the model is used with infrared cameras and can be directly applied with cooled CCD cameras. However, uncooled cameras are characterized by a temperature detector variation T_d which involves sensor noise and quantum efficiency η_e modifications mainly due to the variation of the absorption light. As a result, the model parameters depend on detector temperature and a temperature calibration allows to determine their values. In this section, we present results in the case of a camera based on a Sony detector.

A. Temperature-Signal Relation

Fig. 1 illustrates an imaging COD directly viewing a hot source with a photon luminance L_s during integration time ti . Ideally, such a system produces a number of photoelectrons N_{pe} at a collection site given by

$$N_{pe} = K_o ti \int_{\Delta\lambda} \tau_a(\lambda) \tau_w(\lambda) \tau_f(\lambda) \tau_o(\lambda) L_s(\lambda) \eta_e(\lambda, T_d) d\lambda \quad (2)$$

where K_o is the optical focused magnification ($K_o = (\pi A_{pix}) / (4N^2)$), N is the F-number and A_{pix} is the sensitive pixel area. τ_a , τ_w , τ_f , and τ_o are respectively atmospheric, window glass, near infrared filter and optical system transmittance. η_e is the detector's quantum efficiency (e^-)/photons. Such a model can be improved: for example [9] describes nonlinearities in short exposure time (< 40 ms) due to the mechanical nature of the shutter mechanism.

The charge packets integrated at each collection site are transferred in parallel with a charge transfer efficiency (CTE ≈ 1) into an output register. Before the next parallel transfer, the register transfers each of its charge packets to a floating diode acting as a capacitor C_c . The difference voltage V_c of the capacitor is amplified with a gain G_c and the final value is linearly proportional to the number of electrons N_{pe}

$$V_c = \frac{G_c}{C_c} q N_{pe}(\lambda, T_d) \quad (3)$$

where q is the electronic charge ($q = 1.6 \cdot 10^{-19}$ Coulomb).

Finally, the signal generated by the camera CCD (full range value is named V_{cFR}) is converted into a digital signal I_D with a resolution of n bits and is amplified with a gain G_D

$$I_D = \frac{G_D 2^n}{V_{cFR}} V_c(\lambda, T_d). \quad (4)$$

Relation (4) shows that the output signal I_D depends on the spectral quantum efficiency and on transmission and source

Fig. 2. Cross section of photomos structure.

characteristics. From this relation, the radiometric model can be determined using the following steps.

- 1) In the case of a CCD detector operating in NIR spectral band, a very small wavelength range $\Delta\lambda$ equals to $0.35 \mu\text{m}$ is selected. The integral can then be computed around an effective wavelength λ_e . L_s will only vary in the source temperature $T(L_s(\lambda_e, T))$ and η_e depends only on the detector temperature [$\eta_e(\lambda_e, T_d)$].
- 2) During the temperature calibration procedure with a controlled atmosphere and with the same window, filter, and optical system, we can consider transmittances τ_a , τ_w , τ_f , and τ_o as constants. In our system, only F-number N , exposure time, ti and analog-to-digital converter gain G_D can be modified

$$I_D = A_1 \frac{G_D ti}{N^2} L_s(\lambda_e, T) \eta_e(\lambda_e, T_d) \quad (5)$$

where A_1 is a constant ($A_1 = \tau_a \tau_w \tau_f \tau_o (2^n / V_{cFR}) (G_c / C_c) q (\pi A_{pix} / 4)$).

- 3) The luminance $L_s(\lambda_e, T)$ is described by the Planck's blackbody radiation law (1) with an emissivity $\varepsilon_{BB} \approx 1$

$$I_D = \frac{A_2 \frac{G_D ti}{N^2}}{\exp\left(\frac{B}{T}\right) - 1} \eta_e(\lambda_e, T_d) \quad (6)$$

where A_2 and B are constants ($A_2 = A_1 \varepsilon_{BB} C_3 \lambda_e^{-4}$ and $B = C_2 / \lambda_e$).

- 4) Moreover, we introduce in relation (6) a variable D to model continuous value of camera output in dark environment. The value of D also depends on the effect of noise sources of the CCD imaging system which are highly linked to the detector temperature.

Finally, the temperature-signal relation is described by

$$I_D = \frac{A_2 \frac{G_D ti}{N^2} \eta_e(\lambda_e, T_d)}{\exp\left(\frac{B}{T}\right) - 1} + D(T_d). \quad (7)$$

B. Detector's Quantum Efficiency Model η_e

The detector's quantum efficiency is defined as the ratio of electron flux N_{pe} to incident photon flux N_p onto the optical system for a single collection site and a particular exposure time

$$\eta_e(\lambda_e, T_d) = \frac{N_{pe}(\lambda_e, T_d)}{N_p}. \quad (8)$$

In photomos devices, we can approximate the quantum efficiency by that of an abrupt half junction. We assume that the front part of photomos structure is close to zero (see Fig. 2).

Fig. 3. α as a function of λ and T_d .

The quantum efficiency is then defined by the sum of the depletion region ZD efficiency (η_{ZD}) and back region P efficiency (η_P). With reference [10], η_{ZD} and η_P are given by

$$\eta_{ZD} = 1 - \exp(-\alpha\chi_p) \quad (9)$$

$$\eta_P = \frac{(\alpha L_n)^2}{(\alpha L_n)^2 - 1} \left(\exp(-\alpha\chi_p) + \frac{\exp(-\alpha L) - \exp(-\alpha\chi_p) \cosh\left(\frac{L-\chi_p}{L_n}\right)}{\alpha L_n \sinh\left(\frac{L-\chi_p}{L_n}\right)} \right) \quad (10)$$

where L_n , L , and χ_p are respectively electron diffusion length in region P (mm), substrate length (mm), and limit of depletion region (mm). α represents the absorption photons coefficient in silicon part (see formula in Appendix). Fig. 3 shows the evolution of this coefficient versus the wavelength at different temperatures. It decreases with an increasing wavelength and a decreasing temperature.

Therefore, the quantum efficiency of the detector is defined as a function of the wavelength and the temperature owing to absorption coefficient characteristics

$$\eta_e = 1 + \exp(-\alpha L) \left(\frac{K_a}{K_b} \right) + \exp(-\alpha\chi_p) \left(\frac{K_a}{K_b} \left(K_b - \frac{K_b}{K_a} - \cosh\left(\frac{L-\chi_p}{L_n}\right) \right) \right) \quad (11)$$

where K_a and K_b are variable ($K_a = (\alpha L_n)^2 / ((\alpha L_n)^2 - 1)$ and $K_b = \alpha L_n \sinh((L - \chi_p) / (L_n))$).

To model the quantum efficiency of the detector, we have to determine the internal parameters (L_n , L , and χ_p) of the detector. However, these parameters can generally not be accessed easily. One solution can be to measure the quantum efficiency and to fit the parameters of model (11). Another way to deal with this problem is to correct the constant value of the quantum efficiency known at a reference temperature T_{dref} with a law $f(\lambda, T_d)$ versus the wavelength and the temperature, as shown in (12)

$$\eta_e(\lambda, T_d) = \eta_e(\lambda, T_{dref}) f(\lambda, T_d). \quad (12)$$

In NIR spectral band, the expression of f is obtained from relation (11) and is defined by a macroscopic diffusion law, as follows:

$$f = f_2(T_d) (\exp(f_1(\lambda, T_d)) + \exp(-f_1(\lambda, T_d)))^{sign} \quad (13)$$

where $sign$ is equal to 1 when $(T_d - T_{dref}) \geq 0$ and -1 on the contrary, while f_1 is given by

$$f_1(\lambda, T_d) = K_1(\lambda_{norm})^{K_2} (T_{dnorm})^{K_3} \quad (14)$$

where:

- $\lambda_{norm} = (\lambda - \lambda_{min}) / (\lambda_{max}(T_d) - \lambda_{min})$, λ_{max} and λ_{min} are respectively maximum and minimum wavelengths of NIR spectral band ($\lambda_{max} = (hc) / (E_g(T_d)q)$, $\lambda_{min} = 0.75 \mu m$). E_g is the energy gap (eV) ($E_g = 1.1557 - (7.0210^{-4} T_d^2) / (1108 + T_d)$) (see formula in [11]).

Fig. 4. Noise transfer diagram.

- $T_{dnorm} = |T_d - T_{dref}| / (T_{dmax} - T_{dref})$, T_{dmax} is the maximal detector temperature.

Finally, f_2 is a constant K_4 raised to power of normalized detector temperature T_{dnorm} . To obtain a ratio of 1 when $T_d = T_{dref}$, we divide this term by 2. We get

$$f_2(T_d) = \frac{(K_4)^{T_{dnorm}}}{2}. \quad (15)$$

According to the first step of the determination of radiometric model, we compute the relation (12) at an effective wavelength λ_e

$$\eta_e(\lambda_e, T_d) = \eta_e(\lambda_e, T_{dref}) f(\lambda_e, T_d). \quad (16)$$

From model (16), the temperature-signal relation (7) is modified as follows:

$$I_D = \frac{A_3 \frac{G_D ti}{N^2} f(\lambda_e, T_d)}{\exp\left(\frac{B}{T}\right) - 1} + D(T_d) \quad (17)$$

where A_3 is a constant ($A_3 = A_2 \eta_e(\lambda_e, T_{dref})$).

C. Coefficient D Model: Temporal Source Noise

We model coefficient D by the sum of a constant I_{DO} and a variable $\overline{I_D}$ scaling the temperature T_d . I_{DO} is associated with an offset and with noise sources independent of temperature. We assume that noise is independent of signal level and spatial variations. Therefore, we get

$$D(T_d) = I_{DO} + \overline{I_D}(T_d). \quad (18)$$

Many books and articles (i.e., [12]), describe noise sources depending on the detector temperature. We have represented the main ones on Fig. 4.

The main source noise comes from dark current generated by thermal generation in silicon. It has been shown that the mean background dark current level increases with the temperature T_d (Kelvin) and the integration time $ti(s)$, as follows:

$$V_{cdark} = ti A_{pix} \left(A_{dark} T_d^\beta \right)^{\frac{1}{2}} \exp - \frac{E_g(T_d)q}{2kT_d} \quad (19)$$

where A_{dark} and β are constant ($\beta = 3$ in silicon device).

Considering zero as the mean value of the reset noise, we add to the model (19) a linear dependence with temperature which comes from a drift of electronic components. Then, the mean

value of the digital output $\overline{I_D}$ fluctuates with temperature, as follows:

$$\overline{I_D} = G_D \left(K_5 ti T_d^{\frac{3}{2}} \exp - \frac{E_g(T_d)q}{2kT_d} + K_6 T_d \right) \quad (20)$$

where K_5 and K_6 are constant ($K_5 = (2n/V_{cFR}) A_{dark}^{1/2}$).

D. Conclusion of Radiometric Model Expression

Finally, (21) describes our complete radiometric model with nine parameters (A_3 , B , I_{DO} , K_1 , K_2 , K_3 , K_4 , K_5 , and K_6) which must be fitted during a calibration procedure

$$I_D = \frac{A_3 \frac{G_D ti}{N^2} f(\lambda_e, T_d)}{\exp\left(\frac{B}{T}\right) - 1} + D(T_d). \quad (21)$$

where

$$f = f_2 (\exp(f_1) + \exp(-f_1))^{sign}$$

$$f_1 = K_1 (\lambda_{norm})^{K_2} (T_{dnorm})^{K_3}$$

$$f_2 = \frac{(K_4)^{T_{dnorm}}}{2}$$

$$D = I_{DO} + \overline{I_D}(T_d)$$

$$I_{DO} = \text{constant}$$

$$\overline{I_D} = G_D \left(K_5 ti T_d^{\frac{3}{2}} \exp - \frac{E_g(T_d)q}{2kT_d} + K_6 T_d \right).$$

E. Radiometric Model Calibration

First, from the CCD camera model (21), we estimate the dependence of the output signal noise fl function of the detector temperature to fix the I_{DO} , K_5 , and K_6 parameters. Then, to fit missing parameters, the CCD camera has been calibrated using blackbody temperatures from 320 to 460 °C intervals with detector temperature variation range $-30 + 52$ °C.

On our experiments, we have tested several kinds of CCD cameras but we present only the results for the VHR 2000 CCD camera manufactured by Digital Vision. The CCD is a Sony ICX 039 752(H) $\times$ 582(V) array of 8.6(H) $\times$ 8.3(V) μm^2 pixels. This camera has a linear response with exposure time. We add Kodak Wratten 87C near infrared selected filter. All experimental tests have taken place in a dark environment where the detector temperature T_d was regulated with an air-conditioned enclosure.

1) *Observations of System Noise:* In a dark environment and when the detector temperature T_d is adjusted between -30 and $+60$ °C, we compute the mean value D of the digital image. Considering an exposure time ti of 20 ms and a unitary gain G_D , Fig. 5 shows a linear evolution for D until temperature reaches 20 °C. Above this temperature, D increases exponentially mainly because of current noise. By fitting equation (18) to these D values, we have deduced I_{DO} , K_5 , and K_6 parameters which are provided in Table I.

This model allows to estimate correctly the noise fluctuations for our uncooled CCD camera. Note that long exposure time requires a frame integration time concept. Charges are collected simultaneously but are read out alternately. Changing the gate voltage shifts the image centroid by half a pixel in vertical direction. This creates 50% overlap and therefore pixel sensitivity is doubled. This effect leads to an average of the noise.

Fig. 5. D as a function of T_d .

TABLE I
PARAMETERS VALUES OF MODEL (18)

I_{D0}	K_5	K_6
2.41	$1.794 \cdot 10^{+5}$	$2.31 \cdot 10^{-2}$

Fig. 6. Experiment for radiometric calibration.

2) *Temperature Calibration:* In order to estimate the missing parameters of model (21), we have directly illuminated the camera by a nearly spatially uniform blackbody (see Fig. 6). In order to cover a maximum of pixels, we have used a blackbody with a large cavity (64-mm aperture). The temperature range is from 20 to 550 °C. For a focal length f of 8 mm, a F-number N of 1.4, an integration time t_i of 360 ms, and an output amplifier gain G_D of 1.41, we have computed the mean

Fig. 7. (1) Black-body uniform region.

value (I_D) over a number of repeated image central regions (see Fig. 7). Within these experimental conditions, a value of I_D over the range [0–255 Gray Levels] involves a black-body temperature range from 300 to 460 °C. Of course, with a lower time exposure value, it is possible to increase the blackbody temperature without signal saturation.

Using these experimental points (T, I_D), the calibration procedure to estimate the A_3, B, K_1, K_2, K_3 , and K_4 parameters of model (21) is as follows.

- 1) For the reference detector temperature T_{dref} : A_3 and B determination.

Fig. 8. Calibration and verification curves for different T_d .

Usually, the manufacturer gives data at a reference temperature T_{dref} of 20 °C. In this case, the correction function $f(\lambda_e, T_d)$ of the detector temperature is a unitary function in model (21). Curve 1 of Fig. 8 shows experimental points and model with A_3 and B estimated parameters.

- 2) For a different temperature T_d : K_1, K_2, K_3 , and K_4 determination.

With a temperature different from T_{dref} , knowing A_3 and B parameters, we can estimate the parameters of the function $f(\lambda_e, T_d)$. The results of experiment and estimation procedure obtained with a detector temperature T_d of 50 °C.

- 3) Experimental verification of the model (21).

Considering the previous fitted parameters of model (21) and for a different value T_d of -30 °C, curve (3) of Fig. 8 represents experimental and computed results. The difference between experimental and calculated curve is lower than 1% of object temperature. Including all uncertainties, the model (21) with fitted parameters provided in Table II can be accepted.

TABLE II
PARAMETERS VALUES OF MODEL (21)

A_3	B	K_1	K_2	K_3	K_4
$1.011 \cdot 10^{+12}$	$1.505 \cdot 10^{+4}$	1.743	1.396	0.631	1.018

be extended to detector temperature lower than -30 °C down to -50 °C. At the other end, for temperatures higher than 50 °C up to 80 °C (CCD detector is still operating), no experiment shows the validity of the model. However, we can observe a high level of dark current (see Fig. 5). Knowing the detector temperature with an external sensor, the radiometric model (21) allows object temperature correction of 25 °C for a gray level value of 100 (see Fig. 8).

Particularly, in a measurement context, it is important to qualify the radiometric model performances in terms of signal-to-noise ratio (SNR) and noise equivalent temperature difference (NETD) as functions of detector temperature T_d . Our goal described in the introduction, is to measure a low object temperature T of 350 °C with uncertainty value of ± 25 °C. At this object temperature, Fig. 9 illustrates the SNR as a function of the temperature detector T_d for different exposure time. The signal is provided by model (21) and the square root of the noise variance comes from the model (18). We observe a maximum SNR at a detector temperature T_d of 18 °C. Below this temperature value, the quantum efficiency limits the SNR value. At high detector temperature, dark current dominates and the SNR decreases. The NETD criterion is defined as the ratio of the standard deviation noise to the sensitivity that

F. Performances

Our experiments have taken into account detector temperature variations in the radiometric model (21) over a range from -30 to 50 °C. We model effects related to detector temperature in quantum efficiency due to variation in light absorption. In the reference of absorption coefficient formulas [13], the model can

Fig. 9. SNR as function of T_d .

represents the derivative radiometric model (21) in function of object temperature T . We compute it for an object temperature T_0 of 350 °C. The result of NETD versus temperature and for different exposure time is plotted in Fig. 10. In the same way, NETD curves present also a minimum at detector temperature of 18 °C. For a low detector temperature, sensitivity increases more than noise. On the contrary, for a high detector temperature, noise dominates.

As a conclusion, high detector temperatures degrade camera performances, but it is possible to adjust exposure time t_i to respect values of SNR or NETD. For example, at reference detector temperature, to measure over the range from 350 to 1000 °C with SNR higher than 2 and an NETD value always higher than 8 °C, five exposure times are required over the range from 0.36 s to 1/10 000 s. The value of F-number N and amplifier output gain G_D are the same as those used in experiments.

III. GEOMETRIC MODEL

This section describes the geometric model of the imaging system (optical lens, camera, and digital card). After an overview of the “pin-hole” model used in our applications, we define their extrinsic and intrinsic parameters to be calibrated. Extrinsic parameters describe the transformation of the object 3-D frame into the camera 3-D frame. The transformation of the latter frame into the image two-dimensional (2-D) frame is expressed by intrinsic parameters. They depend on optic perspective projection and detector CCD spatial resolution. By studying the MTF, we examine the influence of spectral

band and detector temperature on the spatial resolution. This analysis shows that intrinsic parameters depend on spectral band and detector temperature. In this section, we do not discuss the accuracy of intrinsic parameters in function of 3-D error models or 2-D errors introduced by the target detection in the camera image [14].

A. “Pin-Hole” Model

The basic assumption of the “pin-hole” model is that the lens center O_{cam} is the intersection of all optical beams. We assume that the image plane (or CCD detector plane) is perpendicular to optical axis ($O_{cam} - z$). Fig. 11 illustrates the basic geometry of the pin-hole camera model. $R_{obj}(0_{obj}, \vec{X}, \vec{Y}, \vec{Z})$ represents the object 3-D frame, while $R_{cam}(0_{cam}, \vec{x}, \vec{y}, \vec{z})$ denotes the camera 3-D frame and $R_{im}(0_{im}, \vec{u}, \vec{v})$ is the image 2-D frame. Finally, (u_0, v_0) is the principal point, or the optical center (0_{cam}) projection on the CCD detector plane.

Three steps are required to compute the transformation from a point (X, Y, Z) in R_{obj} to a point $p'(u, v)$ in R_{im} .

- 1) Rigid body transformation (rotation R and translation T) of the object coordinates (X, Y, Z) in R_{obj} to camera coordinates (x, y, z) in R_{cam} .
- 2) Perspective projection with center 0_{cam} , axis $\vec{z}$ and ratio f (distance between the CCD detector and the optical center), of the 3-D point (x, y, z) into an image point (i, j, f) expressed in the camera 3-D frame.
- 3) Transformation of camera coordinates (i, j, f) into 2-D image frame coordinates (u, v) using an origin transformation (u_0, v_0) in image plane and a space sampling ac-

Fig. 10. NETD as function of T_d .

Fig. 11. Object and camera coordinate system.

according to the pixel sizes Δx and Δy (considering pixels as adjacent in CCD array). The dependence of pixel sizes on wavelength and detector temperature will be discussed in paragraph III-B.

By combining these three steps, (22) relates the transformation of the 3-D object into the 2-D image frame

$$\begin{pmatrix} u \\ v \end{pmatrix} = \begin{pmatrix} u_0 \\ v_0 \end{pmatrix} + \begin{pmatrix} \frac{f}{\Delta x(\lambda, T_d)} \frac{R_{11}X + R_{12}Y + R_{13}Z + T_x}{R_{31}X + R_{32}Y + R_{33}Z + T_z} \\ \frac{f}{\Delta y(\lambda, T_d)} \frac{R_{21}X + R_{22}Y + R_{23}Z + T_y}{R_{31}X + R_{32}Y + R_{33}Z + T_z} \end{pmatrix}. \quad (22)$$

Model (22) involves 12 extrinsic parameters (nine for rotation R and three for translation T) and four intrinsic parameters [u_0 , v_0 , $\alpha_u = (f/\Delta x(\lambda, T_d))$, $\alpha_v = (f/\Delta y(\lambda, T_d))$]. To simplify the presentation, we do not introduce in this paper the lens distortion correction step described in [15]. We use this correction in our applications.

The model calibration described in [8] or [16] involves a computation of the camera extrinsic and intrinsic parameters based

Fig. 12. Diffusion influence.

on several points which object coordinates (X, Y, Z) in the 3-D object frame R_{obj} are known and which image coordinates (u, v) are measured. These points are extracted from several images of a specific object (planar calibration pattern), moved in front of the camera.

For robotic applications, self-calibration methods [17] have been proposed to recover these parameters on line, using a weak camera model. For our measurement applications, we apply a strong calibration method, which requires two steps: a) using

Fig. 13. MTF_{diff} as a function of λ .

initial estimates of the intrinsic parameters computed from the camera characteristics, the object pose computation [18] gives estimates for the extrinsic parameters for each image acquired on the calibration object. b) Then, from the initial guesses, a non linear minimization method (including the estimation of the distortion coefficients) allows to improve the estimation of these parameters. A basic hypothesis for this procedure is that focal length f and pixel sizes Δx et Δy remain constant. If it is not the case (active camera or fluctuations according to the wavelength and to the detector temperature), they must be estimated again.

The metrology applications require very accurate estimates of the camera parameters: therefore we have to verify if intrinsic parameters, especially $\alpha_u = f/\Delta x$ and $\alpha_v = f/\Delta y$, are changing with spectral band and detector temperature fluctuations. The MTF of the camera characterizes the optic effects and how the discrete locations of detector elements (Δx , Δy) sample spatially the scene in function of wavelength and detector temperature.

B. Camera MTF

The complete MTF of the camera is the product of the optic MTF (MTF_o) and the detector MTF (MTF_d), that is

$$MTF = MTF_o \times MTF_d. \quad (23)$$

1) *Optic MTF_o*: With reference to [19], MTF_o in the horizontal or vertical direction of a radial symmetric optical system

with a clear circular diffraction-limited aperture illuminated monochromatically is given by

$$MTF_o(f_s) = \frac{2}{\pi} \left(\cos^{-1} \left(\frac{f_s}{f_{oc}} \right) - \left(\frac{f_s}{f_{oc}} \right) \sqrt{1 - \left(\frac{f_s}{f_{oc}} \right)^2} \right) \quad (24)$$

where f_{oc} is the cutoff frequency of the optical system ($f_{oc} = (1/N\lambda)$). In NIR spectral band, with an F-number N equal to 1.4, MTF_o is close to 1 (0.998–0.978). The camera MTF can then be approximated by MTF_d

$$MTF \approx MTF_d. \quad (25)$$

The camera cutoff frequency f_c is equal to the detector cutoff frequency f_{dc} .

2) *Detector MTF_d*: CCD detector is a spatial sampler of a horizontal frequency f_{Hs} (respectively vertical f_{Vs}) of the input signal. The highest CCD horizontal frequency reproduced is the Nyquist horizontal frequency f_{HN} (respectively vertical f_{VN}). It is mandatory that the input signal frequency are inferior to Nyquist frequency to respect Shannon theorem and to avoid spatial aliasing. In metrology applications, the Nyquist frequency is the band-limit or the system cutoff frequencies f_{dc} which is defined as half an inverse pixel dimension: $f_{HN} = (1/2\Delta x)$ [respectively, $f_{VN} = (1/2\Delta y)$]. We assume here that pixels are

Fig. 14. MTF_{diff} as a function of T_d .

adjacent. We note that the detector cutoff frequency decreases when the cell area increases.

Moreover of the influence of the detector geometry, in NIR spectral band, the photons absorption occurs at increasing depths along substrate detector depth z . The absorption law Φ approaches an exponential law [$\Phi = C^t \exp(-\alpha z)$] where the coefficient absorption α in the silicon decreases with an increasing wavelength (see Fig. 3). However, the depletion region size ZD is finite (see Fig. 2) and the majority of long wavelength photons will be absorbed outside of the depletion region. An electron generated in substrate will experience a 3-D random walk until it recombines or reaches the edge of neighbor depletion region. In the last case, this phenomenon, called diffusion, creates a response that overlaps other pixels (see Fig. 12 in reference of [13]).

Finally, in NIR spectral band, the detector MTF (MTF_d) results of the product of the geometric MTF (MTF_{geo}) by the diffusion MTF (MTF_{diff}), and it is expressed by

$$MTF_d = MTF_{geo} \times MTF_{diff}. \quad (26)$$

According to [20], the geometric MTF (MTF_{geo}) of a single CCD cell is given by

$$MTF_{geo}(f_{Hs}, f_{Vs}) = \left| \text{sinc} \left(\pi \frac{f_{Hs}}{2f_{HN}} \right) \right| \left| \text{sinc} \left(\pi \frac{f_{Vs}}{2f_{VN}} \right) \right|. \quad (27)$$

In order to simplify the expression, we compute the MTF_{geo} only in one dimension for the horizontal direction x . Therefore, we denote the horizontal input frequency f_{sH} as f_s and horizontal Nyquist frequency f_{HN} as f_N . For $f_N = f_{dc} = f_s$, the MTF_{geo} value is 0.637.

For a front illuminated CCD, the diffusion term MTF_{diff} in reference of [21] can be written as

$$MTF_{diff}(\lambda, T_d) = \frac{1 - \frac{\exp(-\alpha(\lambda, T_d)\chi_p)}{1 + \alpha(\lambda, T_d)L_o(f_s)}}{1 - \frac{\exp(-\alpha(\lambda, T_d)\chi_p)}{1 + \alpha(\lambda, T_d)L_n}} \quad (28)$$

where the factor L_o is the spatial frequency-dependent component of diffusion length L_n ($L_o = L_n / (\sqrt{1 + (2\pi L_n f_s)^2})$) and χ_p is the depletion width (see Fig. 2).

Let us remark that the diffusion term MTF_{diff} depends on the absorption coefficient as a function of wavelength and temperature as shown in Fig. 3.

Fig. 13 shows MTF_{diff} versus wavelength ($\chi_p = 4 \mu\text{m}$, $L_n = 7.1 \mu\text{m}$). For short wavelengths ($\lambda < 0.6 \mu\text{m}$), MTF_{diff} can be neglected and it approaches 1 ($MTF_d \approx MTF_{geo}$). For the NIR spectral band ($\lambda > 0.75 \mu\text{m}$), the diffusion term MTF_{diff} dominates in the MTF_{diff} relation. As illustrated by Fig. 14, the diffusion term MTF_{diff} decreases with the detector temperature.

As a conclusion, in visible spectral band, we can approximate the camera MTF with only the geometric MTF (MTF_{geo}) of the detector

$$MTF = MTF_d = MTF_{geo}. \quad (29)$$

Fig. 15. Bar test target.

Fig. 16. Definition of V_{cmax} and V_{cmin} .

But, in NIR spectral band, the camera MTF must be expressed as the product of the geometric MTF (MTF_{geo}) by the diffusion MTF (MTF_{diff})

$$MTF = MTF_d = MTF_{geo} \times MTF_{diff}. \quad (30)$$

With the same value of MTF ($MTF = 0.637$), the camera cutoff frequency f_c is lower in NIR than in visible spectral band. In addition, its value decreases with the detector temperature. Finally, the pixel effective sizes ($\Delta x = 1/2f_c$) are higher in NIR than in visible spectral band.

C. Experimental Results

Although the camera MTF is defined for sinusoidal signals, the square wave (see Fig. 15) is the most popular test target. The system response to a square-wave target is the contrast transfer function (CTF)

$$CTF(f_s) = \frac{V_{cmax} - V_{cmin}}{V_{cmax} + V_{cmin}} \quad (31)$$

where V_{cmax} and V_{cmin} are respectively maximum and minimum signal levels of white and black bar test (see Fig. 16). To obtain the relationship between square wave and sinusoidal amplitude, we have to express the square wave as cosine series. The

output amplitude is an infinite sum of input cosine amplitudes modified by MTF

$$CTF(f_{s0}) = \frac{4}{\pi} \left| MTF(f_{s0}) - \frac{MTF(3f_{s0})}{3} + \dots \right| \quad (32)$$

where f_{s0} represents the fundamental frequency of the square wave.

For bar target with spatial frequency f_s above $1/3$ of frequency computed to $MTF = 0$, we can write the camera MTF from the measured CTF, as follows:

$$MTF = \frac{\pi}{4} CTF. \quad (33)$$

After measuring the CTF of the VHR 2000 CCD camera tested in paragraph II-E, from (33) we compute the MTF and we compare the cutoff frequency f_c (for a value of 0.637 of the MTF) in visible and in NIR spectral band. We also examine the influence of the detector temperature on the MTF.

1) *MTF as a Function of Wavelength*: Using experimental and model results (MTF, f_s) plotted in Fig. 17, we can compute the cutoff frequency f_c , as follows.

- *In visible spectral band* ($MTF_{diff} \approx 1$):

For a value of 0.637 of the MTF, the value of the cutoff frequency f_c is 45.3 mm^{-1} . From relation ($\Delta x = 1/2f_c$), it easily follows that the value of the detector width Δx is $11 \text{ }\mu\text{m}$. The value is different from the manufacturer's ($\Delta x = 8.6 \text{ }\mu\text{m}$ due to a low pass filter with a cutoff frequency lower than Nyquist frequency to satisfy the Shannon sampling theorem.

- *In NIR spectral band*:

Considering experimental results plotted in Fig. 17, MTF produced in NIR is lower than MTF produced in visible spectral band. We can estimate L_n and χ_p parameters of the diffusion term MTF_{diff} (28) in the model (30). The values are provided in Table III. As a result, the value of the cutoff frequency f_c is 30.50 mm^{-1} leads to a detector width value Δx of $16.39 \text{ }\mu\text{m}$.

We note that the diffusion length value L_n is small. The limited diffusion in substrate can be explained at least in part by a likely epitaxial layer. This fact can be also ascribed to an inadequate 2-D diffusion model to explain 3-D diffusion mechanisms.

As a conclusion, in NIR spectral, MTF decreases and it is equivalent to work with detector sizes 1.34 times higher.

2) *MTF as a function of the detector temperature*: To take into account the effects of the detector temperature, considering previous values of L_n and χ_p parameters (see Table III), we compute the absorption coefficient α (see formulae in Appendix) as a function of detector temperature T_d ranging from -50 to $80 \text{ }^\circ\text{C}$. From these computations and the model (30) in NIR spectral band, we obtain the MTF values versus temperature T_d . For MTF value of 0.637, we can deduce the cutoff frequency f_c and compute the detector width ($\Delta x = 1/2f_c$) as a function of T_d . The Fig. 18 shows a linear decreasing of the detector width Δx with a detector temperature increasing T_d . We can infer the following linear model:

$$\Delta x(T_d) = \Delta x(T_{dref}) - K_7(T_d - T_{dref}) \quad (34)$$

Fig. 17. Experimental verification of MTF.

TABLE III
PARAMETER VALUES OF MODEL (28)

$L_n (\mu m)$	$\chi_p (\mu m)$
7.101	3.36

where K_7 is a parameter which value ($K_7 = 7.235 \cdot 10^{-3}$) has been obtained from the experimental points plotted in Fig. 18.

D. Performances

By studying the MTF as a function of wavelength, we notice that the spatial resolution of the CCD detector decreases with an increasing of wavelength to account for diffusion phenomenon. To fit the intrinsic parameters of the “pin-hole” camera model, the system has been calibrated in NIR spectral band.

The same studies show an increasing of spatial resolution with detector temperature. We propose a correction law (34) of intrinsic parameters α_u , and α_v as a function of detector temperature T_d . With a limited substrate detector by an epitaxial layer, the correction is less necessary than with a thick substrate detector (for example with the detector Hamamatsu S5466). The model calibration has been tested in visible and in NIR spectral band with test points extracted from lozenge center. We estimate intrinsic parameters with method [16] and we obtain α_u and α_v , 1131.17, 1037.34 in visible and, respectively, 1139.53 and 1045.09 in NIR spectral band. The localization error given by method described in is 0.1 mm at an observation distance of 1 m. This experiment should be conducted many times to verify parameters dispersion.

IV. TWO MODELS INTERESTS

In the two previous sections, we have presented radiometric and geometric calibration procedures for an uncooled CCD camera. We emphasize on the fluctuations of the camera parameters with respect to the detector temperature and to the wavelength.

In this section, we show the interest of these two models in order to improve some measurements on a hot object, which can be in any situation in the view field of the camera. In fact, variable orientation θ_s and distance d_s of a hot object could be estimated by a 3-D localization. For monocular vision (only one camera), it could be impossible to locate a single hot point. This point must be associated to a surface belonging to an object. The object position with respect to the camera, can be computed only if the 3-D geometric model of the object has been previously learnt. For an application concerning the monitoring of free-form objects, a rigid visual pattern can be fixed on the object to make this localization easier by using a classical method [8]. For multiocular vision (passive stereo vision), a hot point could be detected and localized using triangulation methods. But, it is required that this point is in the view field of the two cameras. A first estimate on the radiometric attributes, computed without any knowledge on the orientation and the distance, could be used as a stereo-matching criterion. Then, once the point distance is known, the orientation could be computed from local planar approximations, and the radiometric attributes could be refined using the equation (36).

Fig. 18. Δ_x as a function of T_d .

Fig. 19. Description of geometric situation.

In fact, the Fig. 19 shows the geometric situation between a hot source (black body) of area A_s and sensor of area A_d through the optical system of focal length f and area A_o . The hot source sees optical area A_o under the solid angle $\Omega_s = A_o/d_s^2$ (in the same way detector sees optical area A_o under the solid angle $\Omega_d = A_o/d_d^2$). θ_s is the angle between the axis $0_s - 0_d$ and the source normal $\vec{N}_s$ (respectively, θ_d with detector normal $\vec{N}_d$). In measurement situation, angles (θ_s, θ_d) are different from zero, the optical system is not focused and we have to correct the digital output signal measurement I_{Dmes} by the geometric situation, as follows:

$$I_D = \frac{I_{Dmes}}{\frac{A_s f^2 \cos(\theta_s)}{A_d d_s^2}} \quad (35)$$

where θ_d, d_s , and A_3 are provided by localization methods. After correction of I_{Dmes} in relation (35), the radiometric model is inverted to measure the object temperature T with respect to the corrected intensity I_D . Relation (36) provides real object temperature T

$$T = \frac{B}{\ln \left(\frac{A_3 \frac{G_D^{ti}}{N^2} f(T_d)}{I_D - D(T_d)} + 1 \right)}. \quad (36)$$

With any hot source, we must also modify I_{Dmes} by emissivity value ε at effective wavelength λ_e . It is better to work with short wavelength to decrease uncertainty on this emissivity. For example, in [22], a relative emissivity uncertainty $\Delta\varepsilon/\varepsilon$ of 20% leads to a relative temperature uncertainty $\Delta T/T$ of 1.2% at wavelength $\lambda_e = 1 \mu\text{m}$ and of 12% at $\lambda_e = 10 \mu\text{m}$, respectively.

V. CONCLUSION

In this paper, we have described radiometric and geometric models taking into account detector temperature variations based on an uncooled low cost CCD camera operating in the NIR.

Using physical COD properties, we have analyzed the influence of wavelength and detector temperature fluctuations on the radiometric model [see (21)] usually used in cooled infrared thermographic systems. The temperature fluctuations (a) involve quantum efficiency variations due to light absorption and modifications of diffusion mechanisms [see (13)] and (b)

affect sensor noise levels [see (18)] (especially dark current). Experimental calibration results confirm the radiometric model (21) with a COD camera based on a Sony detector over a detector temperature range of -30 to 50 °C. Knowing the detector temperature with an external sensor, this model allows us to correct the object temperature by 10% (see Fig. 8) to compensate detector temperature fluctuations of 80 °C. To obtain the same performances in function of detector temperature variation in terms of SNR or NETD, we propose to adjust the exposure time of the CCD detector. Figs. 9 and 10 show SNR and NETD, respectively, as a function of detector temperature T_d . An optimal point of both criteria at a detector temperature of 18 °C can be exhibited. Moreover, we can measure a hot object over the temperature range of 350 to 1000 °C with a precision lower than ± 25 °C at 350 °C.

On the other hand, by studying the MTF, we have analyzed the detector CCD spatial resolution properties in function of spectral band and detector temperature fluctuations. This analysis establishes that the spatial resolution decreases in NIR spectral band due to a diffusion term MTF_{diff} [see (28)]. This term (MTF_{diff}) depends on the absorption coefficient that is itself wavelength and detector temperature dependent. Therefore, we prove that the spatial cutoff frequency f_c of a CCD detector decreases when the wavelength increases and the detector temperature decreases. As the cutoff frequency is inversely proportional to pixel size $\Delta x(f_c = 1/2\Delta x)$, it is equivalent to work with an effective pixel size which is wavelength- and detector-temperature dependent. The properties are explained in geometric model (22). First, to consider wavelength effects, we have to calibrate the model in NIR spectral band to fit intrinsic parameters with effective pixel sizes. Then, using model (34), the detector temperature correction can be applied in geometric model (22) to compensate a relative error of 0.01% in a displacement of 100 mm. This error could be higher with a thick substrate detector with greater diffusion effects.

We have characterized a low cost sensor to measure surface temperature field and dimensional characteristics. It could also be used in thermal treatment process of tools [23] or super plastic forming (SPF) of Titanium alloy sheets [24].

APPENDIX

According to [13], absorption photons coefficient is given as follows.

(a) For a photon energy E between 1.2 and 2.2 eV

$$\alpha = 2750 \left(\frac{E - 1.1 + 510^{-7}T_d^2}{\exp\left(\frac{348}{T_d}\right) - 1} + \frac{(E - 1.16 + 510^{-7}T_d^2)^2}{1 - \exp\left(\frac{-348}{T_d}\right)} \right). \quad (37)$$

(b) For a photon energy E between 2.2 and 2.5 eV

$$\alpha = \alpha(2.2\text{eV}; T_d) \left(\frac{7447.3}{\alpha(2.2\text{eV}; T_d)} + 0.4491 \right)^{\left(\frac{E}{0.3 - 7.3333} \right)}. \quad (38)$$

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